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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicant:

Robert P. Meagley et al.

Serial No.: 10/688,521

Filed: October 17, 2003

For: Reducing Photoresist Line Edge
Roughness Using Chemically-
Assisted Reflow

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Art Unit: 1752

Examiner: Amanda C. Walke

Docket: ITL.1026US
P16713

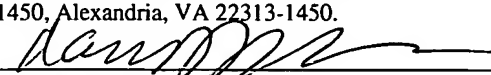
Assignee: Intel Corporation

Mail Stop **Amendment**
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

REPLY TO OFFICE ACTION

Sir:

In response to the office action mailed December 28, 2007, please amend the above-referenced patent application as follows:

Date of Deposit: March 14, 2008
I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Nancy Meshkoff